

HMC-C007

Request a Quote

HMC-C007 Information



For Reference Only

Part Number	HMC-C007
Manufacturer	Analog Devices Inc.
Category	RF/IF and RFID RF Misc ICs and Modules
Description	INGAP HBT DIVIDE-BY-8 MODULE 0.5
Package	Module, SMA Connectors
	For the pricing/inventory/lead time, please contact us Website: https://www.heisener.com E-mail: salesdept@heisener.com



Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



HMC-C007 Specifications

Manufacturer Part Number	HMC-C007
Manufacturer	Analog Devices Inc.
Category	RF/IF and RFID
	RF Misc ICs and Modules
Package	Module, SMA Connectors
Series	-
Function	Divide-by-8
Frequency	500MHz ~ 18GHz
RF Type	VSAT
Secondary Attributes	-
Package / Case	Module, SMA Connectors
Supplier Device Package	Module
	Report errors?

HMC-C007 Guarantees

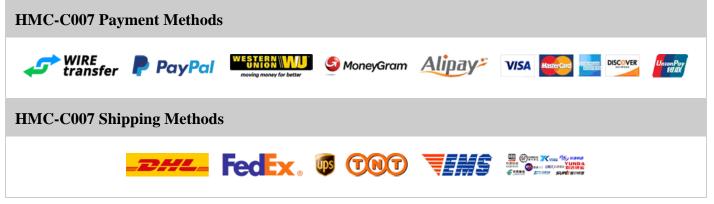


Quality Guarantees

We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.



If you have any question about HMC-C007, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com